

ICS9LPRS464

System Clock Chip for ATI RS/RD600 series chipsets using AMD CPUs

Description

ATI RD/RS600 series systems using AMD CPUs

Output Features

- Integrated Series Resistors on differential outputs
- Greyhound Compatible CPU outputs
- 2 0.7V Low Power differential CPU pairs
- 6 0.7V Low Power differential SRC pairs
- 2 0.7V Low Power differential ATIG pairs
- 1 66 MHz HyperTransport clock
- 2 48MHz USB clocks
- 3 14.318MHz Reference clocks

Pin Configuration

onfigurati	ion			
GNDREF	1		56	FS0/REF0
VDDREF	2		55	FS1/REF1
X1	3		54	FS2/REF2
X2	4		53	**PD
VDD48	5		52	VDDHTT
48MHz_0	6		51	HTTCLK0
48MHz_1	7		50	GNDHTT
GND48			49	*CLKREQA#
SMBCLK				CPUKG0T_LPR
SMBDAT				CPUKG0C_LPR
RESET_IN#				VDDCPU
SRC5T_LPR		4		GNDCPU
SRC5C_LPR		9LPRS464		CPUKG1T_LPR
VDDSRC		ŝ		CPUKG1C_LPR
GNDSRC		Ľ.		VDDA
SRC4T_LPR		6		GNDA
SRC4C_LPR		•		NC
SRC3T_LPR				SRC0T_LPR
SRC3C_LPR				SRC0C_LPR
SRC2T_LPR				GNDSRC
SRC2C_LPR				VDDSRC
GNDSRC				ATIG0T_LPR
VDDSRC				ATIG0C_LPR
SRC1T_LPR				VDDATIG
SRC1C_LPR				GNDATIG
VDDSRC				ATIG1T_LPR
*CLKREQB#		000		*CLKREQC#
	56-Pin S	SOP/	ISSOP	

56-Pin SSOP/TSSOP

* Internal Pull-Up Resistor

** Internal Pull-Down Resistor

IDT™/ICS™ System Clock Chip for ATI RS/RD600 series chipsets using AMD CPUs

Key Specifications

- CPU outputs cycle-to-cycle jitter <150ps
- SRC outputs cycle-to-cycle jitter < 125ps
- ATIG outputs cycle-to-cycle jitter < 125ps
- +/- 100ppm frequency accuracy on all outputs if REF is tuned to +/-100ppm

Features/Benefits:

- 3 Programmable Clock Request pins for SRC and ATIG clocks
- ATIGCLKs are programmable for frequency
- Spread Spectrum for EMI reduction
- Outputs may be disabled via SMBus
- External crystal load capacitors for maximum frequency accuracy

Power Groups

Pin Nu	umber	Description
VDD	GND	Description
5	8	USB_48 outputs
14,23,26,36	15,22,27,37	SRCCLK outputs
33	32	ATIGCLK differential outputs
42	41	Analog, PLL
46	45	CPUCLK8 differential outputs
52	50	HTTCLK output
2	1	REF outputs

Funtionality

FS2	FS1	FS0	CPU	HTT	SRC	ATIG	USB
F 52	F31	F30	MHz	MHz	MHz	MHz	MHz
0	0	0	Hi-Z	Hi-Z	100.00	100.00	48.00
0	0	1	X/2	X/3	100.00	100.00	48.00
0	1	0	230.00	76.67	100.00	100.00	48.00
0	1	1	240.00	80.00	100.00	100.00	48.00
1	0	0	100.00	66.66	100.00	100.00	48.00
1	0	1	133.33	66.66	100.00	100.00	48.00
1	1	0	166.67	66.66	100.00	100.00	48.00
1	1	1	200.00	66.66	100.00	100.00	48.00

Pin Description

PIN #	PIN NAME	TYPE	DESCRIPTION					
1	GNDREF	GND	Ground pin for the REF outputs.					
2	VDDREF	PWR	Ref, XTAL power supply, nominal 3.3V					
3	X1	IN	Crystal input, nominally 14.318MHz					
4	X2	OUT	Crystal output, nominally 14.318MHz					
5	VDD48	PWR	Power pin for the 48MHz outputs and core. 3.3V					
6	48MHz_0	OUT	48MHz clock output.					
7	48MHz_1	OUT	48MHz clock output.					
8	GND48	GND	Ground pin for the 48MHz outputs					
9	SMBCLK	IN	Clock pin of SMBus circuitry, 5V tolerant.					
10	SMBDAT	I/O	Data pin for SMBus circuitry, 5V tolerant.					
11	RESET_IN#	IN	Real Time falling edge triggered input, When asserted, the part initiates a power up reset with the SMBus being reset to it's power up values, and all PLL derived clocks stopped for the duration of Power up Stabilization. REF outputs continue to run.					
12	SRC5T_LPR	OUT	True clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)					
13	SRC5C_LPR	OUT	Complement clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)					
14	VDDSRC	PWR	Supply for SRC, 3.3V nominal					
15	GNDSRC	GND	Ground pin for the SRC outputs					
16	SRC4T_LPR	OUT	True clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)					
17	SRC4C_LPR	OUT	Complement clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)					
18	SRC3T_LPR	OUT	True clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)					
19	SRC3C_LPR	OUT	Complement clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 500hm shunt resistor to GND needed)					
20	SRC2T_LPR	OUT	True clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)					
21	SRC2C_LPR	OUT	Complement clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 500hm shunt resistor to GND needed)					
22	GNDSRC	GND	Ground pin for the SRC outputs					
23	VDDSRC	PWR	Supply for SRC, 3.3V nominal					
24	SRC1T_LPR	OUT	True clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)					
25	SRC1C_LPR	OUT	Complement clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 500hm shunt resistor to GND needed)					
26	VDDSRC	PWR	Supply for SRC, 3.3V nominal					
27	GNDSRC	GND	Ground pin for the SRC outputs					
28	*CLKREQB#	IN	Programmable Clock Request pin for SRC/ATIG/SB_SRC outputs. If output is selected for control, then that output is controlled as follows: 0 = Enabled, 1 = Tri-state					

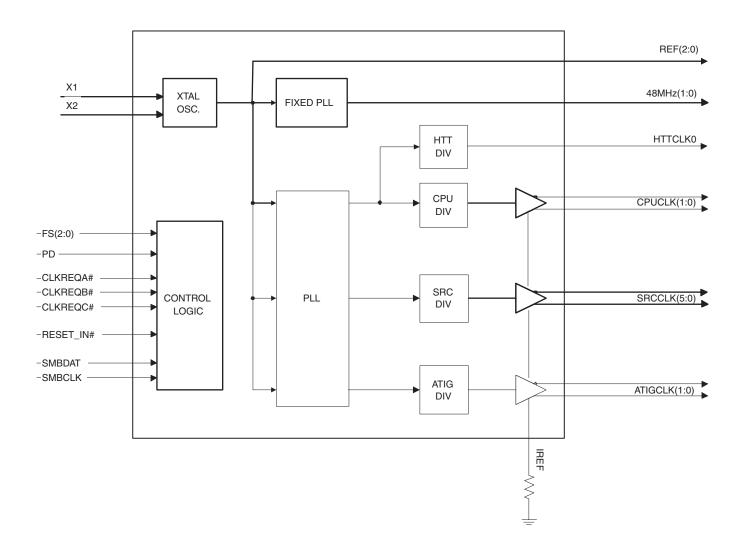
Pin Description (Continued)

PIN #	PIN NAME	ТҮРЕ	DESCRIPTION
29	*CLKREQC#	IN	Programmable Clock Request pin for SRC/ATIG/SB_SRC outputs. If output is selected for control, then that output is controlled as follows: 0 = Enabled, 1 = Tri-state
30	ATIG1C_LPR	OUT	Complementary clock of low-power differential push-pull PCI-Express pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
31	ATIG1T_LPR	OUT	True clock of low-power differential push-pull PCI-Express pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
32	GNDATIG	GND	Ground pin for the ATIG outputs
33	VDDATIG	PWR	Power supply for ATIG core, nominal 3.3V
34	ATIG0C_LPR	OUT	Complementary clock of low-power differential push-pull PCI-Express pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
35	ATIG0T_LPR	OUT	True clock of low-power differential push-pull PCI-Express pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
36	VDDSRC	PWR	Supply for SRC, 3.3V nominal
37	GNDSRC	GND	Ground pin for the SRC outputs
38	SRC0C_LPR	OUT	Complement clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
39	SRC0T_LPR	OUT	True clock of low power differential SRC clock pair with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
40	NC	NC	No Connect
41	GNDA	GND	Ground for the Analog Core
42	VDDA	PWR	3.3V Power for the Analog Core
43	CPUKG1C_LPR	OUT	Complementary signal of low-power differential push-pull AMD K8 "Greyhound" clock with integrated 33 ohm series resistor. (no 500hm shunt resistor to GND needed)
44	CPUKG1T_LPR	OUT	True signal of low-power differential push-pull AMD K8 "Greyhound" clock with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
45	GNDCPU	GND	Ground pin for the CPU outputs
46	VDDCPU	PWR	Supply for CPU, 3.3V nominal
47	CPUKG0C_LPR	OUT	Complementary signal of low-power differential push-pull AMD K8 "Greyhound" clock with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
48	CPUKG0T_LPR	OUT	True signal of low-power differential push-pull AMD K8 "Greyhound" clock with integrated 33 ohm series resistor. (no 50ohm shunt resistor to GND needed)
49	*CLKREQA#	IN	Programmable Clock Request pin for SRC/ATIG/SB_SRC outputs. If output is selected for control, then that output is controlled as follows: 0 = Enabled, 1 = Tri-state
50	GNDHTT	PWR	Ground pin for the HTT outputs
51	HTTCLK0	OUT	3.3V single ended 66MHz hyper transport clock
52	VDDHTT	PWR	Supply for HTT clocks, nominal 3.3V.
53	**PD	IN	Enter /Exit Power Down. 1 = Power Down, 0 = normal operation.
54	FS2/REF2	I/O	Frequency select latch input pin/ 3.3V 14.318MHz reference clock
55	FS1/REF1	I/O	Frequency select latch input pin/ 3.3V 14.318MHz reference clock
56	FS0/REF0	I/O	Frequency select latch input pin/ 3.3V 14.318MHz reference clock

General Description

The ICS9LPRS464 is a main clock synthesizer chip that provides all clocks required for ATI RD/RS600-based systems. An SMBus interface allows full control of the device.

Funtional Block Diagram



Absolute Max

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
3.3V Core Supply Voltage	VDD_A	-			$V_{DD} + 0.5V$	V	1
3.3V Logic Input Supply Voltage	VDD_In	-	GND - 0.5		V _{DD} + 0.5V	V	1
Storage Temperature	Ts	-	-65		150	°C	1
Ambient Operating Temp	Tambient	-	0		70	°C	1
Case Temperature	Tcase	-			115	°C	1
Input ESD protection HBM	ESD prot	-	2000			V	1

¹Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics - Input/Supply/Common Output Parameters

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	Notes
Input High Voltage	V _{IH}	3.3 V +/-5%	2		V _{DD} + 0.3	V	1
Input Low Voltage	V _{IL}	3.3 V +/-5%	V _{ss} - 0.3		0.8	V	1
Input High Current	I _{IH}	$V_{IN} = V_{DD}$	-5 5		5	uA	1
Input Low Current	I _{IL1}	V _{IN} = 0 V; Inputs with no pull-up resistors	-5			uA	1
	I _{IL2}	V _{IN} = 0 V; Inputs with pull-up resistors	-200			uA	1
Low Threshold Input- High Voltage	$V_{\rm IH_FS}$	3.3 V +/-5%	0.7		V _{DD} + 0.3	v	1
Low Threshold Input- Low Voltage	$V_{\rm IL_FS}$	3.3 V +/-5%	V _{SS} - 0.3		0.35	v	1
Operating Current		9LPRS462, all outputs driven			200	mA	1
operating ourrent	I _{DD3.30P}	9LPRS464, all outputs driven			180	mA	1
Powerdown Current	I _{DD3.3PD}	all diff pairs low/low			21	mA	1
Input Frequency	F _i	$V_{DD} = 3.3 V$		14.31818		MHz	2
Pin Inductance	L _{pin}				7	nH	1
	C _{IN}	Logic Inputs			5	pF	1
Input Capacitance	C _{OUT}	Output pin capacitance			6	pF	1
	C _{INX}	X1 & X2 pins			5	pF	1
Clk Stabilization	T _{STAB}	From VDD Power-Up or de- assertion of PD to 1st clock			1.8	ms	1
Modulation Frequency		Triangular Modulation	30		33	kHz	1
Tdrive_PD		CPU output enable after PD de-assertion			300	us	1
Tfall_PD		PD fall time of			5	ns	1
Trise_PD		PD rise time of			5	ns	1
SMBus Voltage	V _{DD}		2.7		5.5	V	1
Low-level Output Voltage	V _{OL}	@ I _{PULLUP}			0.4	V	1
Current sinking at V _{OL} = 0.4 V	I _{PULLUP}		4			mA	1
SMBCLK/SMBDAT Clock/Data Rise Time	T _{RI2C}	(Max VIL - 0.15) to (Min VIH + 0.15)			1000	ns	1
SMBCLK/SMBDAT Clock/Data Fall Time	T _{FI2C}	(Min VIH + 0.15) to (Max VIL - 0.15)			300	ns	1

*TA = 0 - 70°C; Supply Voltage VDD = $3.3 \text{ V} \pm -5\%$

¹Guaranteed by design and characterization, not 100% tested in production.

² Input frequency should be measured at the REF pin and tuned to ideal 14.31818MHz to meet ppm frequency accuracy on PLL outputs.

		•					
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Crossing Point Variation	ΔV_{CROSS}	Single-ended Measurement			140	mV	1,2,5
Frequency	f	Spread Specturm On	198.8		200	MHz	1,3
Long Term Accuracy	ppm	Spread Specturm Off	-300		+300	ppm	1,11
Rising Edge Slew Rate	S _{RISE}	Differential Measurement	0.5		10	V/ns	1,4
Falling Edge Slew Rate	S _{FALL}	Differential Measurement	0.5		10	V/ns	1,4
Slew Rate Variation	t _{SLVAR}	Single-ended Measurement			20	%	1
CPU, DIF HTT Jitter - Cycle to Cycle	CPUJ _{C2C}	Differential Measurement			150	ps	1,6
Accumulated Jitter	t _{JACC}	See Notes			1	ns	1,7
Peak to Peak Differential Voltage	V _{D(PK-PK)}	Differential Measurement	400		2400	mV	1,8
Differential Voltage	VD	Differential Measurement	200		1200	mV	1,9
Duty Cycle	D _{CYC}	Differential Measurement	45		55	%	1
Amplitude Variation	ΔV_D	Change in $V_{\rm D}\text{DC}$ cycle to cycle	-75		75	mV	1,10
CPU Skew	CPU _{SKEW10}	Differential Measurement			100	ps	1

AC Electrical Characteristics - Low-Power DIF Outputs: CPUKG and HTT

Guaranteed by design and characterization, not 100% tested in production.

Single-ended measurement at crossing point. Value is maximum – minimum over all time. DC value of common mode is not important due to the blocking cap.

Minimum Frequency is a result of 0.5% down spread spectrum

Differential measurement through the range of ±100 mV, differential signal must remain monotonic and within slew rate spec when crossing through this region.

⁵ Defined as the total variation of all crossing voltages of CLK rising and CLK# falling. Matching applies to rising edge rate of CLK and falling edge of CLK#. It is measured using a +/-75mV window centered on the average cross point where CLK meets CLK#.

⁶ Max difference of t_{CYCLE} between any two adjacent cycles.

⁷ Accumulated tjc.over a 10 µs time period, measured with JIT2 TIE at 50ps interval.

⁸ VD(PK-PK) is the overall magnitude of the differential signal.

⁹ VD(min) is the amplitude of the ring-back differential measurement, guaranteed by design, that ring-back will not cross 0V VD. VD(max) is the largest amplitude allowed.

¹⁰ The difference in magnitude of two adjacent VD_DC measurements. VD_DC is the stable post overshoot and ring-back part of the signal.

¹¹ All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Rising Edge Slew Rate	t _{SLR}	Differential Measurement	0.5		2	V/ns	1,2
Falling Edge Slew Rate	t _{FLR}	Differential Measurement	0.5		2	V/ns	1,2
Slew Rate Variation	t _{slvar}	Single-ended Measurement			20	%	1
Maximum Output Voltage	V _{HIGH}	Includes overshoot			1150	mV	1
Minimum Output Voltage	V _{LOW}	Includes undershoot	-300			mV	1
Differential Voltage Swing	V _{SWING}	Differential Measurement	300			mV	1
Crossing Point Voltage	V _{XABS}	Single-ended Measurement	300		550	mV	1,3,4
Crossing Point Variation	V _{XABSVAR}	Single-ended Measurement			140	mV	1,3,5
Duty Cycle	D _{CYC}	Differential Measurement	45		55	%	1
SRC, ATIG, Jitter - Cycle to Cycle	SRCJ _{C2C}	Differential Measurement			125	ps	1
SRC[5:0] Skew	SRC _{SKEW}	Differential Measurement			250	ps	1
SB_SRC[1:0] Skew	SRC _{SKEW}	Differential Measurement			100	ps	1
ATIG[3:0] Skew	SRC _{SKEW}	Differential Measurement			100	ps	1

AC Electrical Characteristics - Low-Power DIF Outputs: SRC and ATIG

¹Guaranteed by design and characterization, not 100% tested in production.

² Slew rate measured through Vswing centered around differential zero

³ Vxabs is defined as the voltage where CLK = CLK#

⁴ Only applies to the differential rising edge (CLK rising and CLK# falling)

⁵ Defined as the total variation of all crossing voltages of CLK rising and CLK# falling. Matching applies to rising edge rate of

⁶ All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz

Electrical Characteristics - USB - 48MHz

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	NOTES	
Long Accuracy	ppm	see Tperiod min-max values	see Tperiod min-max values -100 100		ppm	1,2		
Clock period	T _{period}	48.00MHz output nominal	20.8229		20.8344	ns	2	
Clock Low Time	T _{low}	Measure from < 0.6V	9.3750		11.4580	ns	2	
Clock High Time	T _{high}	Measure from > 2.0V	9.3750		11.4580	ns	2	
Output High Voltage	V _{OH}	I _{OH} = -1 mA	2.4			V	1	
Output Low Voltage	V _{OL}	$I_{OL} = 1 \text{ mA}$			0.55	V	1	
Quite ut Lligh Quirrent	L	V _{OH} @MIN = 1.0 V	-33			mA	1	
Output High Current	I _{ОН}	V _{OH} @MAX = 3.135 V			-33	mA	1	
Output Low Current		V _{OL} @ MIN = 1.95 V	30			mA	1	
Output Low Current	I _{OL}	V _{OL} @ MAX = 0.4 V			38	mA	1	
Rise Time	t _{r_USB}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	0.5		1.5	ns	1	
Fall Time	t _{f_USB}	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	0.5		1.5	ns	1	
Duty Cycle	d _{t1}	V _T = 1.5 V	45	-	55	%	1	
Group Skew	t _{skew}	V _T = 1.5 V		-	250	ps	1	
Jitter, Cycle to cycle	t _{jcyc-cyc}	V _T = 1.5 V			130	ps	1,2	

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, CL = 5 pF with Rs = 33Ω (unless otherwise specified)

¹Guaranteed by design and characterization, not 100% tested in production.

²ICS recommended and/or chipset vendor layout guidelines must be followed to meet this specification

PARAMETER	SYMBOL	CONDITIONS MIN TYP MAX		UNITS	Notes		
Long Accuracy	ppm	see Tperiod min-max values	-100	0	100	ppm	1,2
Clock period	T _{period}	14.318MHz output nominal	69.8270	69.84	69.8550	ns	2
Clock Low Time	T _{low}	Measure from < 0.6V	30.9290		37.9130	ns	2
Clock High Time	T _{high}	Measure from > 2.0V	30.9290		37.9130	ns	2
Output High Voltage	V _{OH}	I _{OH} = -1 mA	2.4			V	1
Output Low Voltage	V _{OL}	$I_{OL} = 1 \text{ mA}$	0.4		V	1	
Output High Current	I _{ОН}	V _{OH} @MIN = 1.0 V, V _{OH} @MAX = 3.135 V	-29	-29 -23		mA	1
Output Low Current	I _{OL}	V _{OL} @MIN = 1.95 V, V _{OL} @MAX = 0.4 V	29	29 27		mA	1
Rise Time	t _{r1}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$	1		1.5	ns	1
Fall Time	t _{f1}	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$	1		1.5	ns	1
Skew	t _{sk1}	V _T = 1.5 V			100	ps	1
Duty Cycle	d _{t1}	V _T = 1.5 V 45			55	%	1
Jitter	t _{jcyc-cyc}	V _T = 1.5 V		300	ps	1	

Electrical Characteristics - REF-14.318MHz

*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, CL = 5 pF with Rs = 33Ω (unless otherwise specified)

¹Guaranteed by design and characterization, not 100% tested in production.

² All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz

Table1: CPU and HTT Frequency Selection Table

		yte 0						
Bit4	Bit3	Bit2	Bit1	Bit0	CPUCLK	нтт	Spread	Overclock
CPU SS_EN	CPU FS3	CPU FS2	CPU FS1	CPU FS0	(2:0) (MHz)	(MHz)	%	%
0	0	0	0	0	Hi-Z	Hi-Z	None	
0	0	0	0	1	X / 2	X / 3	None	
0	0	0	1	0	230.00	76.67	None	15%
0	0	0	1	1	240.00	80.00	None	20%
0	0	1	0	0	100.00	66.67	None	
0	0	1	0	1	133.33	66.67	None	0%
0	0	1	1	0	166.67	66.67	None	0 /8
0	0	1	1	1	200.00	66.67	None	
0	1	0	0	0	250.00	83.33	None	25%
0	1	0	0	1	260.00	86.67	None	30%
0	1	0	1	0	270.00	90.00	None	35%
0	1	0	1	1	280.00	93.33	None	40%
0	1	1	0	0	102.00	68.00	None	
0	1	1	0	1	136.00	68.00	None	2%
0	1	1	1	0	170.00	68.00	None	2 /0
0	1	1	1	1	204.00	68.00	None	
1	0	0	0	0	210.00	70.00	-0.5%	5%
1	0	0	0	1	220.00	73.33	-0.5%	10%
1	0	0	1	0	230.00	76.67	-0.5%	15%
1	0	0	1	1	240.00	80.00	-0.5%	20%
1	0	1	0	0	100.00	66.67	-0.5%	
1	0	1	0	1	133.33	66.67	-0.5%	0%
1	0	1	1	0	166.67	66.67	-0.5%	0 /0
1	0	1	1	1	200.00	66.67	-0.5%	
1	1	0	0	0	250.00	83.33	-0.5%	25%
1	1	0	0	1	260.00	86.67	-0.5%	30%
1	1	0	1	0	270.00	90.00	-0.5%	35%
1	1	0	1	1	280.00	93.33	-0.5%	40%
1	1	1	0	0	102.00	68.00	-0.5%	I
1	1	1	0	1	136.00	68.00	-0.5%	2%
1	1	1	1	0	170.00	68.00	-0.5%	د /٥
1	1	1	1	1	204.00	68.00	-0.5%	

Table2: SRC Frequency Selection Table

Byte 0		Byt	e 5				600
Bit 5	Bit3	Bit2	Bit1	Bit0	SRC(7:0)	Spread	SRC
SRC	SRC	SRC	SRC	SRC	(MHz)	%	OverClock
SS EN	FS3	FS2	FS1	FS0	. ,		%
0	0	0	0	0	100.00	0	0%
0	0	0	0	1	101.00	0	1%
0	0	0	1	0	102.00	0	2%
0	0	0	1	1	103.00	0	3%
0	0	1	0	0	104.00	0	4%
0	0	1	0	1	105.00	0	5%
0	0	1	1	0	106.00	0	6%
0	0	1	1	1	107.00	0	7%
0	1	0	0	0	100.00	0	0%
0	1	0	0	1	101.00	0	1%
0	1	0	1	0	102.00	0	2%
0	1	0	1	1	103.00	0	3%
0	1	1	0	0	104.00	0	4%
0	1	1	0	1	105.00	0	5%
0	1	1	1	0	106.00	0	6%
0	1	1	1	1	107.00	0	7%
1	0	0	0	0	100.00	-0.25%	0%
1	0	0	0	1	101.00	-0.25%	1%
1	0	0	1	0	102.00	-0.25%	2%
1	0	0	1	1	103.00	-0.25%	3%
1	0	1	0	0	104.00	-0.25%	4%
1	0	1	0	1	105.00	-0.25%	5%
1	0	1	1	0	106.00	-0.25%	6%
1	0	1	1	1	107.00	-0.25%	7%
1	1	0	0	0	100.00	-0.5%	0%
1	1	0	0	1	101.00	-0.5%	1%
1	1	0	1	0	102.00	-0.5%	2%
1	1	0	1	1	103.00	-0.5%	3%
1	1	1	0	0	104.00	-0.5%	4%
1	1	1	0	1	105.00	-0.5%	5%
1	1	1	1	0	106.00	-0.5%	6%
1	1	1	1	1	107.00	-0.5%	7%

Table3: ATIG Frequency Selection Table

Byte 0		By	te 9				
Bit 6	Bit4	Bit3	Bit1	Bit0	ATIG(2:0)	Spread	ATIG
ATIG	ATIG	ATIG	ATIG	ATIG	(MHz)	Spreau %	OverClock
SS_EN	FS3	FS2	FS1	FS0	、 <i>,</i>		%
0	0	0	0	0	100.00	0	0%
0	0	0	0	1	105.00	0	5%
0	0	0	1	0	110.00	0	10%
0	0	0	1	1	115.00	0	15%
0	0	1	0	0	120.00	0	20%
0	0	1	0	1	125.00	0	25%
0	0	1	1	0	130.00	0	30%
0	0	1	1	1	135.00	0	35%
0	1	0	0	0	100.00	0	0%
0	1	0	0	1	105.00	0	5%
0	1	0	1	0	110.00	0	10%
0	1	0	1	1	115.00	0	15%
0	1	1	0	0	120.00	0	20%
0	1	1	0	1	125.00	0	25%
0	1	1	1	0	130.00	0	30%
0	1	1	1	1	135.00	0	35%
1	0	0	0	0	100.00	-0.25%	0%
1	0	0	0	1	105.00	-0.25%	5%
1	0	0	1	0	110.00	-0.25%	10%
1	0	0	1	1	115.00	-0.25%	15%
1	0	1	0	0	120.00	-0.25%	20%
1	0	1	0	1	125.00	-0.25%	25%
1	0	1	1	0	130.00	-0.25%	30%
1	0	1	1	1	135.00	-0.25%	35%
1	1	0	0	0	100.00	-0.5%	0%
1	1	0	0	1	105.00	-0.5%	5%
1	1	0	1	0	110.00	-0.5%	10%
1	1	0	1	1	115.00	-0.5%	15%
1	1	1	0	0	120.00	-0.5%	20%
1	1	1	0	1	125.00	-0.5%	25%
1	1	1	1	0	130.00	-0.5%	30%
1	1	1	1	1	135.00	-0.5%	35%

Table 4: CPU Divider Ratios

B19b(7:4)	Divider (3:2)								
	Bit	00		01		10		11	MSB
(1:0)	00	0000	2	0100	4	1000	8	1100	16
	01	0001	3	0101	6	1001	12	1101	24
ide	10	0010	5	0110	10	1010	20	1110	40
Divider	11	0011	15	0111	30	1011	60	1111	120
	LSB	Address	Div	Address		Address	Div	Address	Div

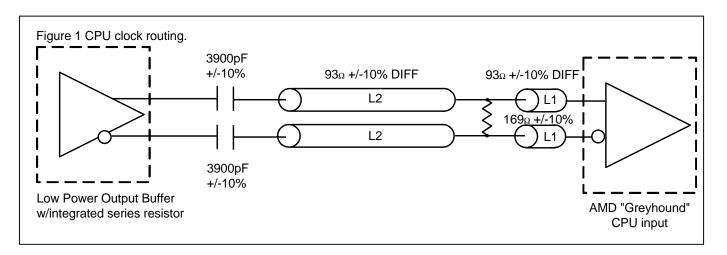
Table 5: HTT Divider Ratios

B20b(3:0)	Divider (3:2)								
	Bit	00		01		10		11	MSB
(1:0)	00	0000	4	0100	8	1000	16	1100	32
	01	0001	3	0101	6	1001	12	1101	24
Divider	10	0010	5	0110	10	1010	20	1110	40
Div	11	0011	15	0111	30	1011	60	1111	120
	LSB	Address	Div	Address		Address	Div	Address	Div

Table 6: ATIG Divider Ratios

B19b(3:0)	Divider (3:2)								
	Bit	00		01		10		11	MSB
(1:0)	00	0000	2	0100	4	1000	8	1100	16
	01	0001	3	0101	6	1001	12	1101	24
Divider	10	0010	5	0110	10	1010	20	1110	40
Div	11	0011	7	0111	14	1011	28	1111	56
	LSB	Address	Div	Address		Address	Div	Address	Div

CPU Clock			
Common Recommendations for Differential Routing	Dimension or Value	Unit	Figure
L1 length, Route as coupled 93 ohm trace.	0.5 max	inch	1
L2 length, Route as coupled 93 ohm trace.	Contact AMD	inch	1



SRC Reference Clock							
Common Recommendations for Differential Routing	Dimension or Value	Unit	Figure				
L1 length, Route as non-coupled 50 ohm trace.	0.5 max	inch	2				
L2 length, Route as non-coupled 50 ohm trace.	N/A	inch	2				
L3 length, Route as non-coupled 50 ohm trace.	N/A	inch	2				
Rs	33	ohm	2				
Rt	49.9	ohm	2				
Down Device Differential Routing	Dimension or Value	Unit	Figure				

Down Device Differential Routing	Dimension or Value	Unit	Figure
L4 length, Route as coupled microstrip 100 ohm differential trace.	2 min to 16 max	inch	2
L4 length, Route as coupled stripline 100 ohm differential trace.	1.8 min to 14.4 max	inch	2

Differential Routing to PCI Express Connector	Dimension or Value	Unit	Figure
L4 length, Route as coupled microstrip 100 ohm differential trace.	0.25 to 14 max	inch	3
L4 length, Route as coupled stripline 100 ohm differential trace.	0.225 min to 12.6 max	inch	3

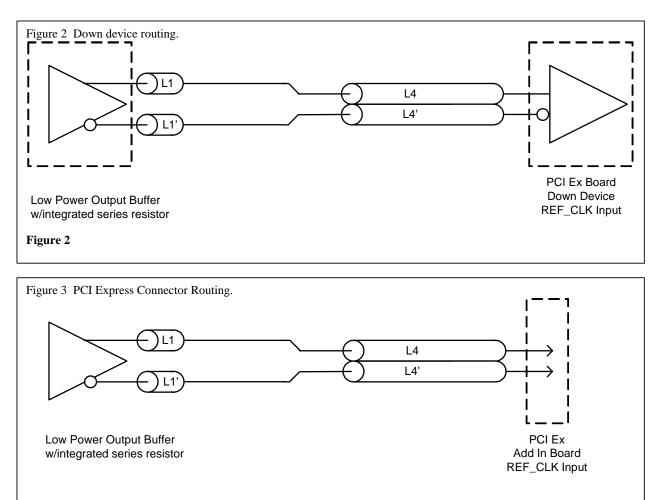


Figure 3

General SMBus serial interface information for the ICS9LPRS464

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D2 (H)
- ICS clock will *acknowledge*
- Controller (host) sends the begining byte location = N
- ICS clock will *acknowledge*
- Controller (host) sends the data byte count = X
- ICS clock will *acknowledge*
- Controller (host) starts sending Byte N through Byte N + X -1
- ICS clock will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address D2 (H)
- ICS clock will acknowledge
- Controller (host) sends the begining byte location = N
- ICS clock will acknowledge
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address D3 (H)
- ICS clock will acknowledge
- ICS clock will send the data byte count = X
- ICS clock sends Byte N + X -1
- ICS clock sends Byte 0 through byte X (if X_(H) was written to byte 8).
- Controller (host) will need to acknowledge each byte
- · Controllor (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

In	Index Block Write Operation							
Со	ntroller (Host)		ICS (Slave/Receiver)					
Т	starT bit							
Slav	e Address D2 _(H)							
WR	WRite							
			ACK					
Beg	inning Byte = N							
			ACK					
Data	Byte Count = X							
			ACK					
Begir	nning Byte N							
			ACK					
	0	ę						
	0	X Byte	0					
	0	\times	0					
			Ō					
Byt	e N + X - 1							
			ACK					
Р	stoP bit							

In	dex Block Rea	ad	Operation		
Cor	troller (Host)	IC	S (Slave/Receiver)		
Т	starT bit				
Slave	e Address D2 _(H)				
WR	WRite				
			ACK		
Begi	nning Byte = N				
			ACK		
RT	Repeat starT				
Slave	e Address D3 _(H)				
RD	ReaD				
		ACK			
		Data Byte Count = X			
	ACK				
			Beginning Byte N		
	ACK				
		fe	0		
	0	X Byte	0		
	0		0		
0					
			Byte N + X - 1		
N	Not acknowledge				
Р	stoP bit				

SMBus Table: Spread Spectrum Enable and CPU Frequency Select Register

Byte 0	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	FS Source	Latched Input or SMBus Frequency Select	RW	Latched Inputs	SMBus	0
Bit 6	-	ATIG SS_EN	ATIG Spread Spectrum Enable RW Disable Enable		Enable	0	
Bit 5	-	SRC SS_EN	SRC Spread Spectrum Enable	RW	Disable	Enable	0
Bit 4	-	CPU SS_EN	CPU Spread Spectrum Enable	RW	Disable	Enable	0
Bit 3	-	CPU FS3	CPU Freq Select Bit 3	RW	See T	able 1:	0
Bit 2	-	CPU FS2	CPU Freq Select Bit 2	RW	CPU Freque		Latch
Bit 1	-	CPU FS1	CPU Freq Select Bit 1	RW		ble	Latch
Bit 0	-	CPU FS0	CPU Freq Select Bit 0	RW	Tu Iu	510	Latch

Note: Each Spread Spectrum Enable bit is independent from the other.

Bit(6:4) must all set to "1" in order to enable spread for CPU, SRC and ATIG clocks.

SMBus Table: Output Control Register

Byte 1	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	7	48MHz_1	48MHz_1 Output Enable	RW	Disable	Enable	1
Bit 6	6	48MHz_0	48MHz_0 Output Enable	RW	Disable	Enable	1
Bit 5	54	REF2	REF2 Output Enable	RW	Disable	Enable	1
Bit 4	55	REF1	REF1 Output Enable	RW	Disable	Enable	1
Bit 3	56	REF0	REF0 Output Enable	RW	Disable	Enable	1
Bit 2	51	HTTCLK0	HTTCLK0 Output Enable	RW	Disable	Enable	1
Bit 1	44,43	CPUCLK1	CPUCLK1 Output Enable	RW	Disable	Enable	1
Bit 0	48,47	CPUCLK0	CPUCLK0 Output Enable	RW	Disable	Enable	1

SMBus Table: ATIGCLK and CLKREQB# Output Control Register

Byte 2	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7			Reserved				0
Bit 6			Reserved				0
Bit 5	31,30	ATIGCLK1	ATIGCLK1 Output Enable	RW	Disable	Enable	1
Bit 4	35,34	ATIGCLK0	ATIGCLK0 Output Enable	RW	Disable	Enable	1
Bit 3	20,21	REQBSRC2	CLKREQB# Controls SRC2	RW	Does not control	Controls	0
Bit 2			Reserved				0
Bit 1	24,25	REQBSRC1	CLKREQB# Controls SRC1	RW	Does not control	Controls	0
Bit 0			Reserved				0

SMBus Table: SRCCLK Output Control Register

Byte 3	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	12,13	SRCCLK5		RW	Disable	Enable	1
Bit 6	16,17	SRCCLK4		RW	Disable	Enable	1
Bit 5	18,19	SRCCLK3	Maatax Outrut control Enchlos	RW	Disable	Enable	1
Bit 4	20,21	SRCCLK2	Master Output control. Enables or disables output, regardless of	RW	Disable	Enable	1
Bit 3		Reserved	CLKREQ# inputs.	-	-	-	1
Bit 2	24,25	SRCCLK1		RW	Disable	Enable	1
Bit 1		Reserved]	-	-	-	1
Bit 0	39,38	SRCCLK0		RW	Disable	Enable	1

Byte 4	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	12,13	REQASRC5	CLKREQA# Controls SRC5	RW	Does not control	Controls	0
Bit 6	16,17	REQASRC4	CLKREQA# Controls SRC4	RW	Does not control	Controls	0
Bit 5	18,19	REQASRC3	CLKREQA# Controls SRC3	RW	Does not control	Controls	0
Bit 4			Reserved				0
Bit 3			Reserved				0
Bit 2	31,30	REQCATIG1	CLKREQC# Controls ATIG1	RW	Does not control	Controls	0
Bit 1	35,34	REQCATIG0	CLKREQC# Controls ATIG0	RW	Does not control	Controls	0
Bit 0	39,38	REQCSRC0	CLKREQC# Controls SRC0	RW	Does not control	Controls	0

SMBus Table: CLKREQB# and CLKREQC# Output Control Register

SMBus Table: CPU Stop Control and SRC Frequency Select Register

Byte 5	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7		IO_VOUT2	IO Output Voltage Select (Most Significant Bit)	RW	See Table 8: \	/ IO Solaction	1
Bit 6		IO_VOUT1	IO Output Voltage Select	RW	(Default	0	
Bit 5		ΙΟ_VOUT0	IO Output Voltage Select (Least Significant Bit)	RW	(Delauli	1	
Bit 4			Reserved				0
Bit 3	-	SRC FS3	SRC Freq Select Bit 3	RW	0 T	abla O	0
Bit 2	-	SRC FS2	SRC Freq Select Bit 2	RW	See I SRC Freque	able 2: how Selection	0
Bit 1	-	SRC FS1	SRC Freq Select Bit 1	RW	Table		0
Bit 0	-	SRC FS0	SRC Freq Select Bit 0	RW			0

SMBus Table: Device ID Register

Byte 6	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	Device ID7 (MSB)		R	-	-	0
Bit 6	-	Device ID6		R	-	-	1
Bit 5	-	Device ID5		R	-	-	1
Bit 4	-	Device ID4	DEVICE ID	R	-	-	0
Bit 3	-	Device ID3	DEVICE ID	R	-	-	0
Bit 2	-	Device ID2		R	-	-	1
Bit 1	-	Device ID1		R	-	-	0
Bit 0	-	Device ID0 (LSB)		R	-	-	0

SMBus Table: Revision and Vendor ID Register

Byte 7	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	RID3		R	-	-	0
Bit 6	-	RID2	REVISION ID	R	-	-	0
Bit 5	-	RID1	REVISION ID	R	-	-	0
Bit 4	-	RID0		R	-	-	0
Bit 3	-	VID3		R	-	-	0
Bit 2	-	VID2	VENDOR ID	R	-	-	0
Bit 1	-	VID1	VENDORID	R	-	-	0
Bit 0	-	VID0		R	-	-	1

SMBus Table: Byte Count Register

Byte 8	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	BC7		RW			0
Bit 6	-	BC6		RW			0
Bit 5	-	BC5		RW	Writing to this	s register will	0
Bit 4	-	BC4	Byte Count Programming b(7:0)	RW	congiure how r	nany bytes will	0
Bit 3	-	BC3	Byte Count Programming b(7.0)	RW	be read back	k, default is 9	1
Bit 2	-	BC2		RW	byt	es.	0
Bit 1	-	BC1		RW			0
Bit 0	-	BC0		RW			1

SMBus Table: REF2, 48MHz Output Strength Control and ATIG Frequency Select Register

Byte 9	Pin #	Name	Control Function	Туре	0	1	PWD		
Bit 7	54	REF2Str	REF2 Strength Control	RW	1X	2X	1		
Bit 6	7	48MHz_1Str	48MHz_1 Strength Control	RW	1X	1			
Bit 5	6	48MHz_0Str	48MHz_0 Strength Control	RW	1X	2X	1		
Bit 4		Reserved							
Bit 3	-	ATIG FS3	ATIG Freq Select Bit 3	RW			0		
Bit 2	-	ATIG FS2	ATIG Freq Select Bit 2	RW	See Tabl	e 3: ATIG	0		
Bit 1	-	ATIG FS1	ATIG Freq Select Bit 1	RW	Frequency S	election Table	0		
Bit 0	-	ATIG FS0	ATIG Freq Select Bit 0	RW			0		

SMBus Table: PLLs M/N Programming Enable and REF1, REF0 Output Strength Control Register

Byte 10	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	M/N_EN	PLLs M/N Programming Enable	RW	Disable	Enable	0
Bit 6	55	REF1Str	REF1 Strength Control	RW	1X	2X	1
Bit 5	56	REF0Str	REF0 Strength Control	RW	1X	2X	1
Bit 4		Reserved					
Bit 3			Reserved				0
Bit 2			Reserved				0
Bit 1		Reserved					
Bit 0			Reserved				0

SMBus Table: CPU PLL VCO Frequency Control Register

Byte 11	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	N Div8	N Divider Prog bit 8	RW	The decimal re	presentation of	Х
Bit 6	-	N Div 9	N Divider Prog bit 9	RW	M and N Divier		
Bit 5	-	M Div5		RW	12 will config	ure the VCO	Х
Bit 4	-	M Div4		RW	frequency. De	efault at power	Х
Bit 3	-	M Div3	M Divider Programming bits	RW	up = latch-in c	or Byte 0 Rom	Х
Bit 2	-	M Div2		RW		requency =	Х
Bit 1	-	M Div1		RW	14.318 x [N	· / -	Х
Bit 0	-	M Div0		RW	[MDiv(5:0)+2]	Х

SMBus Table: CPU PLL VCO Frequency Control Register

Byte 12	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	N Div7		RW	The decimal re	presentation of	Х
Bit 6	-	N Div6		RW	M and N Divier		
Bit 5	-	N Div5		RW	12 will config	ure the VCO	Х
Bit 4	-	N Div4	N Divider Programming b(7:0)	RW	frequency. De	efault at power	Х
Bit 3	-	N Div3		RW	up = latch-in c	r Byte 0 Rom	Х
Bit 2	-	N Div2		RW	table. VCO F		Х
Bit 1	-	N Div1		RW	14.318 x [NI	· · ·	Х
Bit 0	-	N Div0		RW	[MDiv(5:0)+2]	Х
	Svetom (Clock Chip for ATL PS/PD600 s	aries chinesets using AMD CPUs				1377

SMBus Table: CPU PLL Spread Spectrum Control Register

Byte 13	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	SSP7		RW			Х
Bit 6	-	SSP6		RW	These Spread	Spectrum bits	Х
Bit 5	-	SSP5		RW	in Byte 13 and	14 will program	Х
Bit 4	-	SSP4	Spread Spectrum Programming	RW	the spread pe	centage. It is	Х
Bit 3	-	SSP3	b(7:0)	RW	recommende	ed to use ICS	Х
Bit 2	-	SSP2		RW		ole for spread	Х
Bit 1	-	SSP1		RW	progra	mming.	Х
Bit 0	-	SSP0		RW			Х

SMBus Table: CPU PLL Spread Spectrum Control Register

Byte 14	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7			Reserved				0
Bit 6	-	SSP14		RW			Х
Bit 5	-	SSP13		RW	These Spread Spectrum bits		
Bit 4	-	SSP12	Caread Castron Dramanian	RW	in Byte 13 and	Х	
Bit 3	-	SSP11	Spread Spectrum Programming b(14:8)	RW		ecentage. It is ed to use ICS	Х
Bit 2	-	SSP10	D(14.8)	RW	Spread % tab		Х
Bit 1	-	SSP9]	RW	progra		Х
Bit 0	-	SSP8]	RW	progra	Х	

SMBus Table: ATIG PLL VCO Frequency Control Register

Byte 15	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	N Div8	N Divider Prog bit 8	RW	-	Х	
Bit 6	-	N Div9	N Divider Prog bit 9	RW	The decimal re		
Bit 5	-	M Div5		RW	M and N Divier in Byte 17 and 18 will configure the VCO	Х	
Bit 4	-	M Div4	BW	•	Default at power	Х	
Bit 3	-	M Div3	M Divider Programming bits	RW			Х
Bit 2	-	M Div2	RW Frequency = 14.318		Х		
Bit 1	-	M Div1		RW	[NDiv(9:0)+8] / [MDiv(5:0)+2]		Х
Bit 0	-	M Div0		RW		Х	

SMBus Table: ATIG PLL VCO Frequency Control Register

Byte 16	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	N Div7		RW			Х
Bit 6	-	N Div6		RW	The decimal representation of M and N Divier in Byte 17 and		· ^
Bit 5	-	N Div5		RW		,	Х
Bit 4	-	N Div4	N Divider Programming b(7:0)	ivider Programming b(7:0) RW frequency. Default at powe		Х	
Bit 3	-	N Div3		RW	up = Byte 0 Rom table. VCO Frequency = 14.318 x [NDiv(9:0)+8] / [MDiv(5:0)+2]	Х	
Bit 2	-	N Div2		RW		Х	
Bit 1	-	N Div1	-	RW			Х
Bit 0	-	N Div0		RW	[[=().=]	Х

SMBus Table: ATIG PLL Spread Spectrum Control Register

Byte 17	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	SSP7		RW			Х
Bit 6	-	SSP6		RW	These Spread	Spectrum bits	Х
Bit 5	-	SSP5		RW	in Byte 19 and	20 will program	Х
Bit 4	-	SSP4	Spread Spectrum Programming	RW	the spread pecentage. It is		Х
Bit 3	-	SSP3	b(7:0)	RW	recommende	ed to use ICS	Х
Bit 2	-	SSP2		RW	Spread % tal	ole for spread	Х
Bit 1	-	SSP1]	RW	progra	mming.	Х
Bit 0	-	SSP0]	RW	7		Х

SMBus Table: ATIG PLL Spread Spectrum Control Register

Byte 18	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7			Reserved				0
Bit 6	-	SSP14		RW	-	Х	
Bit 5	-	SSP13		RW	These Spread		
Bit 4	-	SSP12	Carood Capatrum Dragramming	RW	in Byte 19 and	Х	
Bit 3	-	SSP11	Spread Spectrum Programming b(14:8)	RW		ecentage. It is	Х
Bit 2	-	SSP10	D(14.8)	RW	 recommended to use ICS Spread % table for spread 	Х	
Bit 1	-	SSP9		RW	programming.		Х
Bit 0	-	SSP8		RW	progra		Х

SMBus Table: CPU and ATIG Divider Ratio Programming Bits Select Register

Byte 19	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7	-	CPU_Div3		RW			Х
Bit 6	-	CPU_Div2	CPU_Divider Ratio	RW	See T	able 4:	Х
Bit 5	-	CPU_Div1	Programming Bits	RW	CPU Divid	der Ratios	Х
Bit 4	-	CPU_Div0		RW			Х
Bit 3	-	ATIG_Div3		RW			Х
Bit 2	-	ATIG_Div2	ATIG_Divider Ratio	RW	See T	able 5:	Х
Bit 1	-	ATIG_Div1	Programming Bits	RW	ATIG Divi	der Ratios	Х
Bit 0	-	ATIG_Div0		RW]		Х

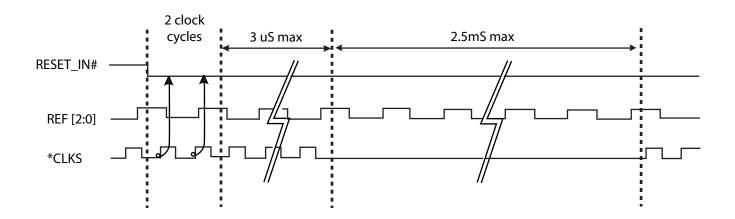
SMBus Table: HTT Divider Ratio Programming Bits Select Register

Byte 20	Pin #	Name	Control Function	Туре	0	1	PWD
Bit 7			Reserved				0
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4			Reserved				0
Bit 3	-	HTT_Div3		RW			Х
Bit 2	-	HTT_Div2	HTT_Divider Ratio	RW	See T	able 6:	Х
Bit 1	-	HTT_Div1	Programming Bits	RW	HTT Divid	der Ratios	Х
Bit 0	-	HTT_Div0		RW			Х

RESET_IN# - Assertion (transition from '1' to '0')

Asserting RESET_IN pin stops all the outputs including CPU, SRC, ATIG, PCI and USB with the REF[2:0] running. The pin is a Schmitt trigger input with debouncing. After it is triggered, REF clocks will wait for two clock cycle to ensure the RESET_IN is asserted. Then, it will take 3uS for the clocks to stop without glitches. The clock chip will be power down and re-power up, and SMBus will be reloaded. It will take no more than 2.5mS for the clocks to come out with correct frequencies and no glitches.

** Deassertion of RESET_IN# (transition from '0' to '1') has NO effect on the clocks.



Shared Pin Operation - Input/Output Pins

The I/O pins designated by (input/output) on the **ICS9LPRS464** serve as dual signal functions to the device. During initial powerup, they act as input pins. The logic level (voltage) that is present on these pins at this time is read and stored into a 5-bit internal data latch. At the end of Power-On reset, (see AC characteristics for timing values), the device changes the mode of operations for these pins to an output function. In this mode the pins produce the specified buffered clocks to external loads.

To program (load) the internal configuration register for these pins, a resistor is connected to either the VDD (logic 1) power supply or the GND (logic 0) voltage potential. A 10 Kilohm (10K) resistor is used to provide both the solid CMOS programming voltage needed during the power-up programming period and to provide an insignificant load on the output clock during the subsequent operating period.

Figure 1 shows a means of implementing this function when a switch or 2 pin header is used. With no jumper is installed the pin will be pulled high. With the jumper in place the pin will be pulled

low. If programmability is not necessary, than only a single resistor is necessary. The programming resistors should be located close to the series termination resistor to minimize the current loop area. It is more important to locate the series termination resistor close to the driver than the programming resistor.

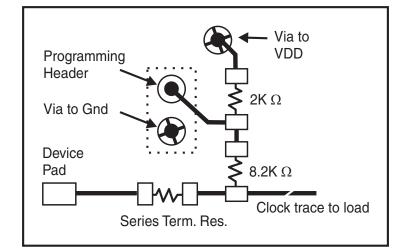
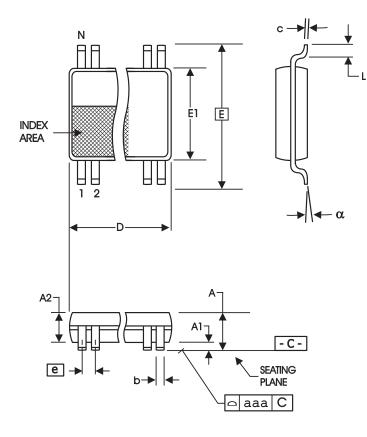


Fig. 1



56-Lead 6.10 mm. Body, 0.50 mm. Pitch TSSOP (240 mil) (20 mil)

	In Millir	neters	In Inc	ches	
SYMBOL	COMMON D	MENSIONS	COMMON D	IMENSIONS	
	MIN	MAX	MIN	MAX	
А		1.20		.047	
A1	0.05	0.15	.002	.006	
A2	0.80	1.05	.032	.041	
b	0.17	0.27	.007	.011	
С	0.09	0.20	.0035	.008	
D	SEE VAR	IATIONS	SEE VAR	IATIONS	
E	8.10 B	ASIC	0.319	BASIC	
E1	6.00	6.20	.236	.244	
е	0.50 B	ASIC	0.020 8	BASIC	
L	0.45	0.75	.018	.030	
N	SEE VAR	IATIONS	SEE VARIATIONS		
α	0°	8°	0°	8°	
aaa		0.10		.004	

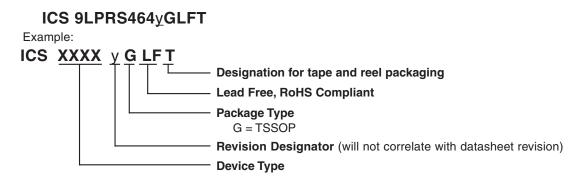
VARIATIONS

N	Dm	m.	D (inch)		
IN	MIN	MAX	MIN	MAX	
56	13.90	14.10	.547	.555	

Reference Doc.: JEDEC Publication 95, MO-153

10-0039

Ordering Information



Revision History

Rev.	Issue Date	Description	Page #
		1. Updated IDD current.	
		2. Added Down device routing Diagram and PCI Express Connector Routing Diagram.	
		3. Going to Release.	5,7-8,13
		4. Updated Rs on REF & USB to 33ohm.	
А	4/7/2008	5. Corrected REF ppm to +/- 100ppm.	

This product is protected by United States Patent NO. 7,342,420 and other patents.

Innovate with IDT and accelerate your future networks. Contact:



For Sales

800-345-7015 408-284-8200 Fax: 408-284-2775

For Tech Support

408-284-6578 pcclockhelp@idt.com

Corporate Headquarters

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road San Jose, CA 95138 United States 800 345 7015 +408 284 8200 (outside U.S.)

Asia Pacific and Japan

Integrated Device Technology Singapore (1997) Pte. Ltd. Reg. No. 199707558G 435 Orchard Road #20-03 Wisma Atria Singapore 238877 +65 6 887 5505

Europe

IDT Europe, Limited Prime House Barnett Wood Lane Leatherhead, Surrey United Kingdom KT22 7DE +44 1372 363 339



© 2006 Integrated Device Technology, Inc. All rights reserved. Product specifications subject to change without notice. IDT and the IDT logo are trademarks of Integrated Device Technology, Inc. All other brands, product names and marks are or may be trademarks or registered trademarks used to identify products or services of their respective owners. Printed in USA